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19 June 2011

Ms. Susanna Kooistra
3GPP MCC
ETSI
650, route des Lucioles
06921 Sophia-Antipolis Cedex
France

Subject: Nomination of candidate for the 3GPP TSG RAN WG3 Chairman

Dear Ms. Kooistra:

QUALCOMM is pleased to nominate Mr. Dino Flore for a second term as Chairman of 3GPP TSG-RAN WG3.

Dino Flore is representing QUALCOMM Incorporated., an ATIS member, in 3GPP.

A brief curriculum vitae of Dino Flore is attached.

Best Regards,

A handwritten signature in black ink, appearing to read "Edward G. Tiedemann, Jr." with a stylized flourish at the end.

Edward G. Tiedemann, Jr.
Senior Vice-President, Engineering
QUALCOMM Incorporated

Dino Flore

Dino Flore received a M.S. degree in Electrical Engineering from the Politecnico di Torino, Italy and a M.S. degree in Mobile Communications from EURECOM Institute, France, in 2000.

From 2001 to 2003 he worked at Arraycomm as Senior Research Engineer on smart antenna technology. In 2003 Dino joined Qualcomm where he is currently serving as a Director of Technical Standards, with various leadership roles in the area of 3GPP RAN standardization over the years.

From 2005 to 2009 Dino contributed to the design and specification of various UMTS and LTE features, through active participation in RAN3 and some sporadic attendance to other 3GPP WGs (RAN2, RAN4, SA2, SA3, SA5), giving him a wide breadth of experience across the layers of the 3GPP system.

In August 2009 Dino was elected as Chairman of RAN3. During his two years of service, he has led the group to the successful completion of the Rel-9 and Rel-10 versions of the RAN3 specifications, including the implementation of multiple new features. As RAN3 Chairman, Dino has also contributed to various project management discussions in RAN.